

MicroVision to Showcase the Capabilities of Its PicoP® Scanning Technology for Display, Interactive Display, and 3D LiDAR Sensing at CES 2018

Company to highlight advances for brighter displays and enhanced 3D LiDAR sensing that can be used as standalone applications or combined for interactive display in one integrated engine

LAS VEGAS--(BUSINESS WIRE)-- <u>MicroVision, Inc.</u> (NASDAQ: MVIS), a leader in innovative ultra-miniature projection display and sensing technology, today announced it is showcasing the capabilities of its PicoP® scanning technology for display, interactive display and 3D LiDAR sensing at CES 2018 in Las Vegas, January 9-12, 2018.

MicroVision has announced plans to offer display and sensing engines based on the ability of its patented PicoP® scanning technology to enable projected displays for personal projection products and AR and VR applications, interactive display that integrates projected display and 3D sensing for touch and gesture recognition, and 3D LiDAR sensing for consumer and automotive applications. MicroVision has prepared demonstrations that highlight its advances in these areas that the company will be featuring in its meeting suites at CES 2018.

<u>Display</u>: MicroVision will be showcasing an assessment unit of the brighter display it is developing and an adaptation of its display engine to project on see-through glass.

<u>Interactive Display</u>: MicroVision will be demonstrating its latest engine form factor and its ability to capture objects using 3D sensing while simultaneously projecting images and content.

<u>3D LiDAR Sensing</u>: The company's demonstration system highlights the small form factor the company plans for this engine product. The demonstration showcases how MicroVision technology creates a new class of 3D LiDAR sensor that is expected to be smaller and more cost-effective than products currently available in the market.

In 2017 the company launched a commercial display engine and announced plans for a brighter display, delivered development kits of its interactive display engine for customer evaluation, and made significant progress developing its 3D LiDAR sensing engine.

Visits to MicroVision's suites at CES are by invitation only. OEMs interested in learning more about MicroVision's technology and arranging a demonstration should contact bd@microvision.com.

About MicroVision

MicroVision is the creator of PicoP® scanning technology, an ultra-miniature laser projection and sensing solution based on the laser beam scanning methodology pioneered by the company. MicroVision's platform approach for this advanced display and sensing solution means that it can be adapted to a wide array of applications and form factors. It is an advanced solution for a rapidly evolving, always-on world. Extensive research has led MicroVision to become an independently recognized leader in the development of intellectual property. MicroVision's IP portfolio has been recognized by the Patent Board as a top 50 IP portfolio among global industrial companies and has been included in the Ocean Tomo 300 Patent Index. The company is based in Redmond, Wash.

For more information, visit the company's website at www.microvision.com, on Facebook at www.microvision.com, on the way at www.microvision.com, on the way at www.microvision.com, on the way at www.mi

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Forward-Looking Statements

Certain statements contained in this release, including those relating to future product and product applications, new technologies and statements using words like "plans," "expected," and similar words are forward-looking statements that involve a number of risks and uncertainties. Factors that could cause actual results to differ materially from those projected in the company's forward-looking statements include the following: our ability to raise additional capital when needed; products incorporating our PicoP® scanning technology may not achieve market acceptance, commercial partners may not perform under agreements as anticipated, we may be unsuccessful in identifying parties interested in paying any amounts or amounts we deem desirable for the purchase or license of IP assets, our or our customers failure to perform under open purchase orders; our financial and technical resources relative to those of our competitors; our ability to keep up with rapid technological change; government regulation of our technologies; our ability to enforce our intellectual property rights and protect our proprietary technologies; the ability to obtain additional contract awards; the timing of commercial product launches and delays in product development; the ability to achieve key technical milestones in key products; dependence on third parties to develop, manufacture, sell and market our products; potential product liability claims; and other risk factors identified from time to time in the company's SEC reports, including the company's Annual Report on Form 10-K filed with the SEC. Except as expressly required by federal securities laws, we undertake no obligation to publicly update or revise any forward-looking statements, whether as a result of new information, future events, changes in circumstances or any other reason.

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